

RF exposure Estimation

1. Introduction

Product: Tracking Module \Fitness module

Model no.: C-XT001-B, C-XF001-B

FCC ID: 2AN2D-000003

EUT is a Bluetooth Tracking Module \Fitness module, which contain Bluetooth function inside.

2. Limit and Guidelines on Exposure to Electromagnetic Fields

According to §15.247(e)(i) and §1.1307(b)(1), systems operating under the provisions of this section shall be operated in a manner that ensure that the public is not exposed to radio frequency energy level in excess of the Commission's guideline.

According to KDB 447498 Mobile Portable RF Exposure, no SAR required if power is lower than the flowing threshold:

The 1-g and 10-g SAR test exclusion thresholds for 100 MHz to 6 GHz at test separation distances \leq 50 mm are determined by:

$[(\text{max. power of channel, including tune-up tolerance, mW}) / (\text{min. test separation distance, mm})] \cdot [\sqrt{f(\text{GHz})}] \leq 3.0 \text{ for 1-g SAR and } \leq 7.5 \text{ for 10-g extremity SAR, where}$

- $f(\text{GHz})$ is the RF channel transmit frequency in GHz
- Power and distance are rounded to the nearest mW and mm before calculation
- The result is rounded to one decimal place for comparison
- 3.0 and 7.5 are referred to as the numeric thresholds in the step 2 below

The test exclusions are applicable only when the minimum test separation distance is \leq 50 mm and for transmission frequencies between 100 MHz and 6 GHz. When the minimum test separation distance is $<$ 5 mm, a distance of 5 mm according to 5) in section 4.1 is applied to determine SAR test exclusion.

3. Calculation method

$[(\text{max. power of channel, including tune-up tolerance, mW}) / (\text{min. test separation distance, mm})] \cdot [\sqrt{f(\text{GHz})}] \leq 3.0$

Conducted Power + tune up tolerance = -4.79dBm=0.33mW

Distance = 5 mm

$f = 2.402 \text{ GHz}$

$[0.33/5] * \text{SQRT}(2.402) = 0.102$

$0.102 \leq 3.0$

Therefore, excluded from SAR testing.

TUV SUD China, Shenzhen Branch

Reviewed by:



Phoebe Hu/ EMC Section Manager
Date: 2017-11-28

Prepared By:



Aaron Lai/EMC Project Engineer
Date: 2017-11-28